**General Description**

The MAX11661–MAX11666 are 12-/10-/8-bit, compact, low-power, successive approximation analog-to-digital converters (ADCs). These high-performance ADCs include a high-dynamic range sample-and-hold and a high-speed serial interface. These ADCs accept a full-scale input from 0V to the power supply or to the reference voltage.

The MAX11662/MAX11664/MAX11666 feature dual, single-ended analog inputs connected to the ADC core using a 2:1 MUX. The devices also include a separate supply input for data interface and a dedicated input for reference voltage. In contrast, the single-channel devices generate the reference voltage internally from the power supply.

These ADCs operate from a 2.2V to 3.6V supply and consume only 3.3mW. The devices include full power-down mode and fast wake-up for optimal power management and a high-speed 3-wire serial interface. The 3-wire serial interface directly connects to SPI, QSPI™, and MICROWIRE® devices without external logic.

Excellent dynamic performance, low voltage, low power, ease of use, and small package size make these converters ideal for portable battery-powered data-acquisition applications, and for other applications that demand low-power consumption and minimal space.

These ADCs are available in a 10-pin µMAX® package, and a 6-pin SOT23 package. These devices operate over the -40°C to +125°C temperature range.

**Applications**

- Data Acquisition
- Portable Data Logging
- Medical Instrumentation
- Battery-Operated Systems
- Communication Systems
- Automotive Systems

---

**Features**

- 500ksps Conversion Rate, No Pipeline Delay
- 12-/10-/8-Bit Resolution
- 1-/2-Channel, Single-Ended Analog Inputs
- Low-Noise 73dB SNR
- Variable I/O: 1.5V to 3.6V (Dual-Channel Only) allows the Serial Interface to Connect Directly to 1.5V, 1.8V, 2.5V, or 3V Digital Systems
- 2.2V to 3.6V Supply Voltage
- Low Power
  - 3.3mW
  - Very Low Power Consumption at 8µA/ksps
- External Reference Input (Dual-Channel Devices Only)
- 1.3µA Power-Down Current
- SPI-/QSPI-/MICROWIRE-Compatible Serial Interface
- 10-Pin, 3mm x 5mm µMAX Package
- 6-Pin, 2.8mm x 2.9mm SOT23 Package
- Wide -40°C to +125°C Operation

---

**Ordering Information**

<table>
<thead>
<tr>
<th>PART</th>
<th>PIN-PACKAGE</th>
<th>BITS</th>
<th>NO. OF CHANNELS</th>
</tr>
</thead>
<tbody>
<tr>
<td>MAX11661AUT+</td>
<td>6 SOT23</td>
<td>8</td>
<td>1</td>
</tr>
<tr>
<td>MAX11662AUB+</td>
<td>10 µMAX-EP*</td>
<td>8</td>
<td>2</td>
</tr>
<tr>
<td>MAX11663AUT+</td>
<td>6 SOT23</td>
<td>10</td>
<td>1</td>
</tr>
<tr>
<td>MAX11664AUB+</td>
<td>10 µMAX-EP*</td>
<td>10</td>
<td>2</td>
</tr>
<tr>
<td>MAX11665AUT+</td>
<td>6 SOT23</td>
<td>12</td>
<td>1</td>
</tr>
<tr>
<td>MAX11666AUB+</td>
<td>10 µMAX-EP*</td>
<td>12</td>
<td>2</td>
</tr>
<tr>
<td>MAX11666AUB/V+</td>
<td>10 µMAX-EP*</td>
<td>12</td>
<td>2</td>
</tr>
</tbody>
</table>

*Note: All devices are specified over the -40°C to +125°C operating temperature range.

+ Denotes a lead(Pb)-free/RoHS-compliant package.

*EP = Exposed pad.

/V denotes an automotive qualified part.

QSPI is a trademark of Motorola, Inc.
MICROWIRE is a registered trademark of National Semiconductor Corp.
µMAX is a registered trademark of Maxim Integrated Products, Inc.
MAX11661–MAX11666
500ksps, Low-Power, Serial 12-/10-/8-Bit ADCs

ABSOLUTE MAXIMUM RATINGS

<table>
<thead>
<tr>
<th>PARAMETER</th>
<th>SYMBOL</th>
<th>CONDITIONS</th>
<th>MIN</th>
<th>TYP</th>
<th>MAX</th>
<th>UNITS</th>
</tr>
</thead>
<tbody>
<tr>
<td>V&lt;sub&gt;DD&lt;/sub&gt; to GND</td>
<td></td>
<td>-0.3V to +4V</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>REF, OVDD, AIN1, AIN2, AIN to GND</td>
<td></td>
<td>-0.3V to the lower of</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>(V&lt;sub&gt;DD&lt;/sub&gt; + 0.3V) and +4V</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>CS, SCLK, CHSEL, DOUT to GND</td>
<td></td>
<td>-0.3V to the lower of</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>(V&lt;sub&gt;OVDD&lt;/sub&gt; + 0.3V) and +4V</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>AGND to GND</td>
<td></td>
<td>-0.3V to the lower of</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>(V&lt;sub&gt;DD&lt;/sub&gt; + 0.3V) and +4V</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Input/Output Current (all pins)</td>
<td></td>
<td>-0.3V to +0.3V</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Output Current (all pins)</td>
<td></td>
<td>50mA</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

Stresses beyond those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS (MAX11666)

(V<sub>DD</sub> = 2.2V to 3.6V, V<sub>REF</sub> = V<sub>DD</sub>, V<sub>OVDD</sub> = V<sub>DD</sub>, f<sub>SCLK</sub> = 8MHz, 50% duty cycle, 500ksps, C<sub>DOUT</sub> = 10pF, T<sub>A</sub> = -40°C to +125°C, unless otherwise noted. Typical values are at T<sub>A</sub> = +25°C.) (Note 1)

<table>
<thead>
<tr>
<th>PARAMETER</th>
<th>SYMBOL</th>
<th>CONDITIONS</th>
<th>MIN</th>
<th>TYP</th>
<th>MAX</th>
<th>UNITS</th>
</tr>
</thead>
<tbody>
<tr>
<td>DC ACCURACY</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Resolution</td>
<td></td>
<td>12 Bits</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Integral Nonlinearity</td>
<td>INL</td>
<td>±1 LSB</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Differential Nonlinearity</td>
<td>DNL</td>
<td>No missing codes</td>
<td>±1</td>
<td>LSB</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Offset Error</td>
<td>OE</td>
<td>±0.3 LSB</td>
<td>±4</td>
<td>LSB</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Gain Error</td>
<td>GE</td>
<td>Excluding offset and reference errors</td>
<td>±1</td>
<td>±3</td>
<td>LSB</td>
<td></td>
</tr>
<tr>
<td>Total Unadjusted Error</td>
<td>TUE</td>
<td>±1 LSB</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Channel-to-Channel Offset</td>
<td></td>
<td>±0.4 LSB</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Matching</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Channel-to-Channel Gain</td>
<td></td>
<td>±0.05 LSB</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Matching</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>DYNAMIC PERFORMANCE (f&lt;sub&gt;AIN&lt;/sub&gt; = 250kHz)</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Signal-to-Noise and Distortion</td>
<td>SINAD</td>
<td>70 72 dB</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Signal-to-Noise Ratio</td>
<td>SNR</td>
<td>70.5 72.5 dB</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Total Harmonic Distortion</td>
<td>THD</td>
<td>-85 -74.5 dB</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Spurious-Free Dynamic Range</td>
<td>SFDR</td>
<td>75.5 85 dB</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Intermodulation Distortion</td>
<td>IMD</td>
<td>f&lt;sub&gt;1&lt;/sub&gt; = 239.8kHz, f&lt;sub&gt;2&lt;/sub&gt; = 200.2kHz</td>
<td>-84</td>
<td>dB</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Full-Power Bandwidth</td>
<td></td>
<td>-3dB point</td>
<td>40</td>
<td>MHz</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Full-Linear Bandwidth</td>
<td></td>
<td>2.5 MHz</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Small-Signal Bandwidth</td>
<td></td>
<td>45 MHz</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Crosstalk</td>
<td></td>
<td>-90 dB</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
</tbody>
</table>
500ksps, Low-Power, Serial 12-/10-/8-Bit ADCs

ELECTRICAL CHARACTERISTICS (MAX11666) (continued)

(VDD = 2.2V to 3.6V, VREF = VDD, VOVDD = VDD, fSCLK = 8MHz, 50% duty cycle, 500ksps. CDOUT = 10pf, TA = -40°C to +125°C, unless otherwise noted. Typical values are at TA = +25°C.) (Note 1)

<table>
<thead>
<tr>
<th>PARAMETER</th>
<th>SYMBOL</th>
<th>CONDITIONS</th>
<th>MIN</th>
<th>TYP</th>
<th>MAX</th>
<th>UNITS</th>
</tr>
</thead>
<tbody>
<tr>
<td>CONVERSION RATE</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Throughput</td>
<td></td>
<td></td>
<td>5</td>
<td>500</td>
<td></td>
<td>ksps</td>
</tr>
<tr>
<td>Conversion Time</td>
<td></td>
<td></td>
<td>1.56</td>
<td>μs</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Acquisition Time</td>
<td>tACQ</td>
<td></td>
<td>52</td>
<td>ns</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Aperture Delay</td>
<td></td>
<td>From CS falling edge</td>
<td></td>
<td></td>
<td>4</td>
<td>ns</td>
</tr>
<tr>
<td>Aperture Jitter</td>
<td></td>
<td></td>
<td>15</td>
<td>ps</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Serial-Clock Frequency</td>
<td>fCLK</td>
<td></td>
<td>0.08</td>
<td>8</td>
<td>MHz</td>
<td></td>
</tr>
<tr>
<td>ANALOG INPUT (AIN1, AIN2)</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Input Voltage Range</td>
<td>VAIN_</td>
<td></td>
<td>0</td>
<td>VREF</td>
<td>±1</td>
<td>V</td>
</tr>
<tr>
<td>Input Leakage Current</td>
<td>IILA</td>
<td></td>
<td>0.002</td>
<td>μA</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Input Capacitance</td>
<td>CAIN_</td>
<td>Track, Hold</td>
<td>20</td>
<td></td>
<td></td>
<td>pF</td>
</tr>
<tr>
<td>EXTERNAL REFERENCE INPUT (REF)</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Reference Input Voltage Range</td>
<td>VREF</td>
<td></td>
<td>1</td>
<td>VDD +</td>
<td>0.05</td>
<td>V</td>
</tr>
<tr>
<td>Reference Input Leakage Current</td>
<td>IILR</td>
<td>Conversion stopped</td>
<td>0.005</td>
<td>μA</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Reference Input Capacitance</td>
<td>CREF</td>
<td></td>
<td>5</td>
<td></td>
<td></td>
<td>pF</td>
</tr>
<tr>
<td>DIGITAL INPUTS (SCLK, CS, CHSEL)</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Digital Input High Voltage</td>
<td>VIH</td>
<td></td>
<td>0.75 x</td>
<td>VOVDD</td>
<td></td>
<td>V</td>
</tr>
<tr>
<td>Digital Input Low Voltage</td>
<td>VIL</td>
<td></td>
<td>0.25 x</td>
<td>VOVDD</td>
<td></td>
<td>V</td>
</tr>
<tr>
<td>Digital Input Hysteresis</td>
<td>VHYST</td>
<td></td>
<td>0.15 x</td>
<td>VOVDD</td>
<td></td>
<td>V</td>
</tr>
<tr>
<td>Digital Input Leakage Current</td>
<td>IIL</td>
<td>Inputs at GND or VDD</td>
<td>0.001</td>
<td>±1</td>
<td>μA</td>
<td></td>
</tr>
<tr>
<td>Digital Input Capacitance</td>
<td>CIN</td>
<td></td>
<td>2</td>
<td></td>
<td></td>
<td>pF</td>
</tr>
<tr>
<td>DIGITAL OUTPUT (DOUT)</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Output High Voltage</td>
<td>VOH</td>
<td>ISOURCE = 200μA</td>
<td>0.85 x</td>
<td>VOVDD</td>
<td></td>
<td>V</td>
</tr>
<tr>
<td>Output Low Voltage</td>
<td>VOL</td>
<td>ISINK = 200μA</td>
<td>0.15 x</td>
<td>VOVDD</td>
<td></td>
<td>V</td>
</tr>
<tr>
<td>High-Impedance Leakage Current</td>
<td>IOL</td>
<td></td>
<td></td>
<td>±1.0</td>
<td>μA</td>
<td></td>
</tr>
<tr>
<td>High-Impedance Output Capacitance</td>
<td>COUT</td>
<td></td>
<td>4</td>
<td></td>
<td></td>
<td>pF</td>
</tr>
</tbody>
</table>
### 500ksps, Low-Power, Serial 12-/10-/8-Bit ADCs

**ELECTRICAL CHARACTERISTICS (MAX11666) (continued)**

(VDD = 2.2V to 3.6V, VREF = VDD, VOCDD = VDD, fSCLK = 8MHz, 50% duty cycle, 500ksps. CDOUT = 10pF, TA = -40°C to +125°C, unless otherwise noted. Typical values are at TA = +25°C.) (Note 1)

<table>
<thead>
<tr>
<th>PARAMETER</th>
<th>SYMBOL</th>
<th>CONDITIONS</th>
<th>MIN</th>
<th>TYP</th>
<th>MAX</th>
<th>UNITS</th>
</tr>
</thead>
<tbody>
<tr>
<td><strong>POWER SUPPLY</strong></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Positive Supply Voltage</td>
<td>VDD</td>
<td></td>
<td>2.2</td>
<td>3.6</td>
<td>V</td>
<td></td>
</tr>
<tr>
<td>Digital I/O Supply Voltage</td>
<td>VOVDD</td>
<td></td>
<td>1.5</td>
<td></td>
<td></td>
<td>V</td>
</tr>
<tr>
<td>Positive Supply Current (Full-Power Mode)</td>
<td></td>
<td></td>
<td>1.67</td>
<td></td>
<td></td>
<td>mA</td>
</tr>
<tr>
<td>Positive Supply Current (Full-Power Mode), No Clock</td>
<td></td>
<td></td>
<td>0.1</td>
<td></td>
<td></td>
<td>mA</td>
</tr>
<tr>
<td>Power-Down Current</td>
<td>IPD</td>
<td>Leakage only</td>
<td>1.3</td>
<td>10</td>
<td></td>
<td>μA</td>
</tr>
<tr>
<td>Line Rejection</td>
<td></td>
<td>VDD = 2.2V to 3.6V, VREF = 2.2V</td>
<td></td>
<td>0.7</td>
<td></td>
<td>LSB/V</td>
</tr>
</tbody>
</table>

**ELECTRICAL CHARACTERISTICS (MAX11665)**

(VDD = 2.2V to 3.6V, fSCLK = 8MHz, 50% duty cycle, 500ksps, CDOUT = 10pF, TA = -40°C to +125°C, unless otherwise noted. Typical values are at TA = +25°C.) (Note 1)

<table>
<thead>
<tr>
<th>PARAMETER</th>
<th>SYMBOL</th>
<th>CONDITIONS</th>
<th>MIN</th>
<th>TYP</th>
<th>MAX</th>
<th>UNITS</th>
</tr>
</thead>
<tbody>
<tr>
<td><strong>DC ACCURACY</strong></td>
<td></td>
<td></td>
<td>12</td>
<td></td>
<td></td>
<td>Bits</td>
</tr>
<tr>
<td>Integral Nonlinearity</td>
<td>INL</td>
<td></td>
<td>±1</td>
<td></td>
<td></td>
<td>LSB</td>
</tr>
<tr>
<td>Differential Nonlinearity</td>
<td>DNL</td>
<td>No missing codes</td>
<td></td>
<td>1</td>
<td></td>
<td>LSB</td>
</tr>
<tr>
<td>Offset Error</td>
<td>OE</td>
<td></td>
<td>±1.5</td>
<td>±4</td>
<td></td>
<td>LSB</td>
</tr>
<tr>
<td>Gain Error</td>
<td>GE</td>
<td>Excluding offset and reference errors</td>
<td></td>
<td>±1</td>
<td>±3</td>
<td></td>
</tr>
<tr>
<td>Total Unadjusted Error</td>
<td>TUE</td>
<td></td>
<td>±1.5</td>
<td></td>
<td></td>
<td>LSB</td>
</tr>
</tbody>
</table>

**DYNAMIC PERFORMANCE (fAIN = 250kHz)**

<table>
<thead>
<tr>
<th>PARAMETER</th>
<th>SYMBOL</th>
<th>CONDITIONS</th>
<th>MIN</th>
<th>TYP</th>
<th>MAX</th>
<th>UNITS</th>
</tr>
</thead>
<tbody>
<tr>
<td>Signal-to-Noise and Distortion</td>
<td>SINAD</td>
<td></td>
<td>70</td>
<td>72.5</td>
<td></td>
<td>dB</td>
</tr>
<tr>
<td>Signal-to-Noise Ratio</td>
<td>SNR</td>
<td></td>
<td>70.5</td>
<td>73</td>
<td></td>
<td>dB</td>
</tr>
</tbody>
</table>
### ELECTRICAL CHARACTERISTICS (MAX11665) (continued)

(V\textsubscript{DD} = 2.2V to 3.6V, f\textsubscript{SCLK} = 8MHz, 50% duty cycle, 500ksps, C\textsubscript{DOUT} = 10pF, T\textsubscript{A} = -40°C to +125°C, unless otherwise noted. Typical values are at T\textsubscript{A} = +25°C.) (Note 1)

<table>
<thead>
<tr>
<th>PARAMETER</th>
<th>SYMBOL</th>
<th>CONDITIONS</th>
<th>MIN</th>
<th>TYP</th>
<th>MAX</th>
<th>UNITS</th>
</tr>
</thead>
<tbody>
<tr>
<td>Total Harmonic Distortion</td>
<td>THD</td>
<td></td>
<td>-85</td>
<td>-76</td>
<td></td>
<td>dB</td>
</tr>
<tr>
<td>Spurious-Free Dynamic Range</td>
<td>SFDR</td>
<td></td>
<td>77</td>
<td>85</td>
<td></td>
<td>dB</td>
</tr>
<tr>
<td>Intermodulation Distortion</td>
<td>IMD</td>
<td>f\textsubscript{1} = 239.8kHz, f\textsubscript{2} = 200.2kHz</td>
<td>-84</td>
<td></td>
<td></td>
<td>dB</td>
</tr>
<tr>
<td>Full-Power Bandwidth</td>
<td>-3dB point</td>
<td></td>
<td>40</td>
<td></td>
<td></td>
<td>MHz</td>
</tr>
<tr>
<td>Full-Linear Bandwidth</td>
<td>SINAD &gt; 68dB</td>
<td></td>
<td>2.5</td>
<td></td>
<td></td>
<td>MHz</td>
</tr>
<tr>
<td>Small-Signal Bandwidth</td>
<td></td>
<td></td>
<td>45</td>
<td></td>
<td></td>
<td>MHz</td>
</tr>
</tbody>
</table>

### CONVERSION RATE

<table>
<thead>
<tr>
<th>PARAMETER</th>
<th>SYMBOL</th>
<th>CONDITIONS</th>
<th>MIN</th>
<th>TYP</th>
<th>MAX</th>
<th>UNITS</th>
</tr>
</thead>
<tbody>
<tr>
<td>Throughput</td>
<td></td>
<td></td>
<td>5</td>
<td>500</td>
<td></td>
<td>ksps</td>
</tr>
<tr>
<td>Conversion Time</td>
<td></td>
<td></td>
<td>1.56</td>
<td></td>
<td></td>
<td>(\mu)s</td>
</tr>
<tr>
<td>Acquisition Time</td>
<td>tACQ</td>
<td></td>
<td>52</td>
<td></td>
<td></td>
<td>ns</td>
</tr>
<tr>
<td>Aperture Delay</td>
<td></td>
<td>From CS falling edge</td>
<td>4</td>
<td></td>
<td></td>
<td>ns</td>
</tr>
<tr>
<td>Aperture Jitter</td>
<td></td>
<td></td>
<td>15</td>
<td></td>
<td></td>
<td>ps</td>
</tr>
<tr>
<td>Serial Clock Frequency</td>
<td>f\textsubscript{CLK}</td>
<td></td>
<td>0.08</td>
<td></td>
<td>8</td>
<td>MHz</td>
</tr>
</tbody>
</table>

### ANALOG INPUT

<table>
<thead>
<tr>
<th>PARAMETER</th>
<th>SYMBOL</th>
<th>CONDITIONS</th>
<th>MIN</th>
<th>TYP</th>
<th>MAX</th>
<th>UNITS</th>
</tr>
</thead>
<tbody>
<tr>
<td>Input Voltage Range</td>
<td>V\textsubscript{AIN}</td>
<td></td>
<td>0</td>
<td>V\textsubscript{DD}</td>
<td>V</td>
<td></td>
</tr>
<tr>
<td>Input Leakage Current</td>
<td>I\textsubscript{ILA}</td>
<td></td>
<td>0.002</td>
<td>±1</td>
<td>(\mu)A</td>
<td></td>
</tr>
<tr>
<td>Input Capacitance</td>
<td>C\textsubscript{AIN}</td>
<td>Track</td>
<td>20</td>
<td></td>
<td></td>
<td>pF</td>
</tr>
<tr>
<td></td>
<td></td>
<td>Hold</td>
<td>4</td>
<td></td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

### DIGITAL INPUTS (SCLK, CS, CHSEL)

<table>
<thead>
<tr>
<th>PARAMETER</th>
<th>SYMBOL</th>
<th>CONDITIONS</th>
<th>MIN</th>
<th>TYP</th>
<th>MAX</th>
<th>UNITS</th>
</tr>
</thead>
<tbody>
<tr>
<td>Digital Input High Voltage</td>
<td>V\textsubscript{IH}</td>
<td>0.75 x V\textsubscript{DD}</td>
<td>V</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Digital Input Low Voltage</td>
<td>V\textsubscript{IL}</td>
<td>0.25 x V\textsubscript{DD}</td>
<td>V</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Digital Input Hysteresis</td>
<td>V\textsubscript{HYST}</td>
<td>0.15 x V\textsubscript{DD}</td>
<td>V</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Digital Input Leakage Current</td>
<td>I\textsubscript{IL}</td>
<td>Inputs at GND or V\textsubscript{DD}</td>
<td>0.001</td>
<td>±1</td>
<td>(\mu)A</td>
<td></td>
</tr>
<tr>
<td>Digital Input Capacitance</td>
<td>C\textsubscript{IN}</td>
<td>2</td>
<td></td>
<td></td>
<td>pF</td>
<td></td>
</tr>
</tbody>
</table>

### DIGITAL OUTPUT (DOUT)

<table>
<thead>
<tr>
<th>PARAMETER</th>
<th>SYMBOL</th>
<th>CONDITIONS</th>
<th>MIN</th>
<th>TYP</th>
<th>MAX</th>
<th>UNITS</th>
</tr>
</thead>
<tbody>
<tr>
<td>Output High Voltage</td>
<td>V\textsubscript{OH}</td>
<td>ISOURCE = 200(\mu)A</td>
<td>0.85 x V\textsubscript{DD}</td>
<td>V</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Output Low Voltage</td>
<td>V\textsubscript{OL}</td>
<td>ISINK = 200(\mu)A</td>
<td>0.15 x V\textsubscript{DD}</td>
<td>V</td>
<td></td>
<td></td>
</tr>
<tr>
<td>High-Impedance Leakage Current</td>
<td>I\textsubscript{OL}</td>
<td></td>
<td>±1.0</td>
<td></td>
<td>(\mu)A</td>
<td></td>
</tr>
<tr>
<td>High-Impedance Output Capacitance</td>
<td>C\textsubscript{OUT}</td>
<td>4</td>
<td></td>
<td></td>
<td>pF</td>
<td></td>
</tr>
</tbody>
</table>

### POWER SUPPLY

<table>
<thead>
<tr>
<th>PARAMETER</th>
<th>SYMBOL</th>
<th>CONDITIONS</th>
<th>MIN</th>
<th>TYP</th>
<th>MAX</th>
<th>UNITS</th>
</tr>
</thead>
<tbody>
<tr>
<td>Positive Supply Voltage</td>
<td>V\textsubscript{DD}</td>
<td></td>
<td>2.2</td>
<td>3.6</td>
<td></td>
<td>V</td>
</tr>
<tr>
<td>Positive Supply Current</td>
<td>I\textsubscript{VDD}</td>
<td>V\textsubscript{AIN} = V\textsubscript{GND}</td>
<td>1.76</td>
<td></td>
<td></td>
<td>mA</td>
</tr>
</tbody>
</table>
**500ksps, Low-Power, Serial 12-/10-/8-Bit ADCs**

(ELECTRICAL CHARACTERISTICS (MAX11665) (continued)

(V\textsubscript{DD} = 2.2V to 3.6V, f\textsubscript{SCLK} = 8MHz, 50% duty cycle, 500ksps, C\textsubscript{DOUT} = 10pF, T\textsubscript{A} = -40°C to +125°C, unless otherwise noted. Typical values are at T\textsubscript{A} = +25°C.) (Note 1)

<table>
<thead>
<tr>
<th>PARAMETER</th>
<th>SYMBOL</th>
<th>CONDITIONS</th>
<th>MIN</th>
<th>TYP</th>
<th>MAX</th>
<th>UNITS</th>
</tr>
</thead>
<tbody>
<tr>
<td>Positive Supply Current (Full-Power Mode), No Clock</td>
<td>( I\textsubscript{VDD} )</td>
<td>( V\textsubscript{DD} = 2.2\text{V to }3.6\text{V} )</td>
<td>1.48</td>
<td>mA</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Power-Down Current</td>
<td>( I\textsubscript{PD} )</td>
<td>Leakage only</td>
<td>1.3</td>
<td>10</td>
<td>( \mu\text{A} )</td>
<td></td>
</tr>
<tr>
<td>Line Rejection</td>
<td></td>
<td>( V\textsubscript{DD} = 2.2\text{V to }3.6\text{V} )</td>
<td>0.7</td>
<td></td>
<td>( \text{LSB/V} )</td>
<td></td>
</tr>
</tbody>
</table>

**TIMING CHARACTERISTICS (Note 2)**

<table>
<thead>
<tr>
<th>PARAMETER</th>
<th>SYMBOL</th>
<th>CONDITIONS</th>
<th>MIN</th>
<th>TYP</th>
<th>MAX</th>
<th>UNITS</th>
</tr>
</thead>
<tbody>
<tr>
<td>Quiet Time</td>
<td>( t\textsubscript{Q} )</td>
<td>(Note 3)</td>
<td>4</td>
<td>ns</td>
<td></td>
<td></td>
</tr>
<tr>
<td>CS Pulse Width</td>
<td>( t\textsubscript{1} )</td>
<td>(Note 3)</td>
<td>10</td>
<td>ns</td>
<td></td>
<td></td>
</tr>
<tr>
<td>CS Fall to SCLK Setup</td>
<td>( t\textsubscript{2} )</td>
<td>(Note 3)</td>
<td>5</td>
<td>ns</td>
<td></td>
<td></td>
</tr>
<tr>
<td>CS Falling Until DOUT High-Impedance Disabled</td>
<td>( t\textsubscript{3} )</td>
<td>(Note 3)</td>
<td>1</td>
<td>ns</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Data Access Time After SCLK Falling Edge</td>
<td>( t\textsubscript{4} )</td>
<td>Figure 2, ( V\textsubscript{DD} = 2.2\text{V to }3.6\text{V} )</td>
<td>15</td>
<td></td>
<td>( \text{ns} )</td>
<td></td>
</tr>
<tr>
<td>SCLK Pulse Width Low</td>
<td>( t\textsubscript{5} )</td>
<td>Percentage of clock period (Note 3)</td>
<td>40</td>
<td>60</td>
<td>%</td>
<td></td>
</tr>
<tr>
<td>SCLK Pulse Width High</td>
<td>( t\textsubscript{6} )</td>
<td>Percentage of clock period (Note 3)</td>
<td>40</td>
<td>60</td>
<td>%</td>
<td></td>
</tr>
<tr>
<td>Data Hold Time From SCLK Falling Edge</td>
<td>( t\textsubscript{7} )</td>
<td>Figure 3</td>
<td>5</td>
<td></td>
<td>( \text{ns} )</td>
<td></td>
</tr>
<tr>
<td>SCLK Falling Until DOUT High-Impedance</td>
<td>( t\textsubscript{8} )</td>
<td>Figure 4 (Note 3)</td>
<td>2.5</td>
<td>14</td>
<td></td>
<td>( \text{ns} )</td>
</tr>
<tr>
<td>Power-Up Time</td>
<td></td>
<td>Conversion cycle (Note 3)</td>
<td></td>
<td>1</td>
<td>Cycle</td>
<td></td>
</tr>
</tbody>
</table>

**ELECTRICAL CHARACTERISTICS (MAX11664)**

(\( V\textsubscript{DD} = 2.2\text{V to }3.6\text{V}, V\textsubscript{REF} = V\textsubscript{DD}, V\textsubscript{OVDD} = V\textsubscript{DD}, f\textsubscript{SCLK} = 8MHz, 50\% duty cycle, 500ksps; C\textsubscript{DOUT} = 10pF, T\textsubscript{A} = -40°C to +125°C, unless otherwise noted. Typical values are at T\textsubscript{A} = +25°C.) (Note 1)

<table>
<thead>
<tr>
<th>PARAMETER</th>
<th>SYMBOL</th>
<th>CONDITIONS</th>
<th>MIN</th>
<th>TYP</th>
<th>MAX</th>
<th>UNITS</th>
</tr>
</thead>
<tbody>
<tr>
<td>DC ACCURACY</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Resolution</td>
<td>( \text{INL} )</td>
<td>( \text{DNL} )</td>
<td>( \text{OE} )</td>
<td>( \text{GE} )</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Integral Nonlinearity</td>
<td></td>
<td></td>
<td></td>
<td>No missing codes</td>
<td>Excluding offset and reference errors</td>
<td></td>
</tr>
<tr>
<td>Differential Nonlinearity</td>
<td></td>
<td></td>
<td></td>
<td>( \pm 0.5 )</td>
<td>( \pm 0.5 )</td>
<td>LSB</td>
</tr>
<tr>
<td>Offset Error</td>
<td></td>
<td></td>
<td></td>
<td>( \pm 0.5 )</td>
<td>( \pm 1.3 )</td>
<td>LSB</td>
</tr>
<tr>
<td>Gain Error</td>
<td></td>
<td></td>
<td></td>
<td>0</td>
<td>( \pm 1.3 )</td>
<td>LSB</td>
</tr>
<tr>
<td>Total Unadjusted Error</td>
<td>( \text{TUE} )</td>
<td></td>
<td></td>
<td>( \pm 0.5 )</td>
<td></td>
<td>LSB</td>
</tr>
<tr>
<td>Channel-to-Channel Offset Matching</td>
<td>( \text{GE} )</td>
<td></td>
<td></td>
<td>( \pm 0.1 )</td>
<td></td>
<td>LSB</td>
</tr>
<tr>
<td>Channel-to-Channel Gain Matching</td>
<td>( \text{TUE} )</td>
<td></td>
<td></td>
<td>( \pm 0.05 )</td>
<td></td>
<td>LSB</td>
</tr>
<tr>
<td>DYNAMIC PERFORMANCE (f\textsubscript{AIN} = 250kHz)</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Signal-to-Noise and Distortion</td>
<td>( \text{SINAD} )</td>
<td></td>
<td></td>
<td>60.5</td>
<td>61.6</td>
<td>dB</td>
</tr>
<tr>
<td>Signal-to-Noise Ratio</td>
<td>( \text{SNR} )</td>
<td></td>
<td></td>
<td>60.5</td>
<td>61.6</td>
<td>dB</td>
</tr>
<tr>
<td>Total Harmonic Distortion</td>
<td>( \text{THD} )</td>
<td></td>
<td></td>
<td>-83</td>
<td>-73</td>
<td>dB</td>
</tr>
<tr>
<td>Spurious-Free Dynamic Range</td>
<td>( \text{SFDR} )</td>
<td></td>
<td></td>
<td>75</td>
<td></td>
<td>dB</td>
</tr>
</tbody>
</table>
MAX11661–MAX11666
500ksps, Low-Power, Serial 12-/10-/8-Bit ADCs

ELECTRICAL CHARACTERISTICS (MAX11664) (continued)
(V_{DD} = 2.2V to 3.6V, V_{REF} = V_{DD}, V_{OVDD} = V_{DD}, f_{SCLK} = 8MHz, 50% duty cycle, 500ksps; C_{DOUT} = 10pF, T_{A} = -40°C to +125°C, unless otherwise noted. Typical values are at T_{A} = +25°C.) (Note 1)

<table>
<thead>
<tr>
<th>PARAMETER</th>
<th>SYMBOL</th>
<th>CONDITIONS</th>
<th>MIN</th>
<th>TYP</th>
<th>MAX</th>
<th>UNITS</th>
</tr>
</thead>
<tbody>
<tr>
<td>Intermodulation Distortion</td>
<td>IMD</td>
<td>f_{1} = 239.8kHz, f_{2} = 200.2kHz</td>
<td>-82</td>
<td></td>
<td></td>
<td>dB</td>
</tr>
<tr>
<td>Full-Power Bandwidth</td>
<td></td>
<td>-3dB point</td>
<td>40</td>
<td></td>
<td></td>
<td>MHz</td>
</tr>
<tr>
<td>Full-Linear Bandwidth</td>
<td></td>
<td>SINAD &gt; 60dB</td>
<td>2.5</td>
<td></td>
<td></td>
<td>MHz</td>
</tr>
<tr>
<td>Small-Signal Bandwidth</td>
<td></td>
<td></td>
<td>45</td>
<td></td>
<td></td>
<td>MHz</td>
</tr>
<tr>
<td>Crosstalk</td>
<td></td>
<td></td>
<td>-90</td>
<td></td>
<td></td>
<td>dB</td>
</tr>
<tr>
<td><strong>CONVERSION RATE</strong></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Throughput</td>
<td></td>
<td></td>
<td>5</td>
<td>500</td>
<td></td>
<td>ksps</td>
</tr>
<tr>
<td>Conversion Time</td>
<td></td>
<td></td>
<td>1.56</td>
<td></td>
<td></td>
<td>µs</td>
</tr>
<tr>
<td>Acquisition Time</td>
<td>t_{ACQ}</td>
<td></td>
<td>52</td>
<td></td>
<td></td>
<td>ns</td>
</tr>
<tr>
<td>Aperture Delay</td>
<td></td>
<td>From CS falling edge</td>
<td>4</td>
<td></td>
<td></td>
<td>ns</td>
</tr>
<tr>
<td>Aperture Jitter</td>
<td></td>
<td></td>
<td>15</td>
<td></td>
<td></td>
<td>ps</td>
</tr>
<tr>
<td>Serial-Clock Frequency</td>
<td>f_{CLK}</td>
<td></td>
<td>0.08</td>
<td>8</td>
<td></td>
<td>MHz</td>
</tr>
</tbody>
</table>

**ANALOG INPUT (AIN1, AIN2)**

<table>
<thead>
<tr>
<th>PARAMETER</th>
<th>SYMBOL</th>
<th>CONDITION</th>
<th>MIN</th>
<th>TYP</th>
<th>MAX</th>
<th>UNITS</th>
</tr>
</thead>
<tbody>
<tr>
<td>Input Voltage Range</td>
<td>V_{AIN+}</td>
<td>0</td>
<td>V_{REF}</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Input Leakage Current</td>
<td>I_{ILA}</td>
<td>0.002</td>
<td>±1</td>
<td>µA</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Input Capacitance</td>
<td>C_{AIN+}</td>
<td>Track</td>
<td>20</td>
<td></td>
<td></td>
<td>pF</td>
</tr>
<tr>
<td></td>
<td></td>
<td>Hold</td>
<td>4</td>
<td></td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

**EXTERNAL REFERENCE INPUT (REF)**

<table>
<thead>
<tr>
<th>PARAMETER</th>
<th>SYMBOL</th>
<th>CONDITION</th>
<th>MIN</th>
<th>TYP</th>
<th>MAX</th>
<th>UNITS</th>
</tr>
</thead>
<tbody>
<tr>
<td>Reference Input Voltage Range</td>
<td>V_{REF}</td>
<td></td>
<td>1</td>
<td>V_{DD}+0.05</td>
<td>V</td>
<td></td>
</tr>
<tr>
<td>Reference Input Leakage Current</td>
<td>I_{ILR}</td>
<td>Conversion stopped</td>
<td>0.005</td>
<td>±1</td>
<td>µA</td>
<td></td>
</tr>
<tr>
<td>Reference Input Capacitance</td>
<td>C_{REF}</td>
<td></td>
<td>5</td>
<td></td>
<td></td>
<td>pF</td>
</tr>
</tbody>
</table>

**DIGITAL INPUTS (SCLK, CS, CHSEL)**

<table>
<thead>
<tr>
<th>PARAMETER</th>
<th>SYMBOL</th>
<th>CONDITION</th>
<th>MIN</th>
<th>TYP</th>
<th>MAX</th>
<th>UNITS</th>
</tr>
</thead>
<tbody>
<tr>
<td>Digital Input High Voltage</td>
<td>V_{IH}</td>
<td></td>
<td>0.75 x V_{OVDD}</td>
<td>V</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Digital Input Low Voltage</td>
<td>V_{IL}</td>
<td></td>
<td>0.25 x V_{OVDD}</td>
<td>V</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Digital Input Hysteresis</td>
<td>V_{HYST}</td>
<td></td>
<td>0.15 x V_{OVDD}</td>
<td>V</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Digital Input Leakage Current</td>
<td>I_{IL}</td>
<td>Inputs at GND or V_{DD}</td>
<td>0.001</td>
<td>±1</td>
<td>µA</td>
<td></td>
</tr>
<tr>
<td>Digital Input Capacitance</td>
<td>C_{IN}</td>
<td></td>
<td>2</td>
<td></td>
<td></td>
<td>pF</td>
</tr>
</tbody>
</table>

**DIGITAL OUTPUT (DOUT)**

<table>
<thead>
<tr>
<th>PARAMETER</th>
<th>SYMBOL</th>
<th>CONDITION</th>
<th>MIN</th>
<th>TYP</th>
<th>MAX</th>
<th>UNITS</th>
</tr>
</thead>
<tbody>
<tr>
<td>Output High Voltage</td>
<td>V_{OH}</td>
<td>IS_{SOURCE} = 200µA</td>
<td>0.85 x V_{OVDD}</td>
<td>V</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Output Low Voltage</td>
<td>V_{OL}</td>
<td>IS_{SINK} = 200µA</td>
<td>0.15 x V_{OVDD}</td>
<td>V</td>
<td></td>
<td></td>
</tr>
<tr>
<td>High-Impedance Leakage Current</td>
<td>I_{OL}</td>
<td></td>
<td>±1.0</td>
<td>µA</td>
<td></td>
<td></td>
</tr>
<tr>
<td>High-Impedance Output Capacitance</td>
<td>C_{OUT}</td>
<td></td>
<td>4</td>
<td></td>
<td></td>
<td>pF</td>
</tr>
</tbody>
</table>
### ELECTRICAL CHARACTERISTICS (MAX11664) (continued)

(V\textsubscript{DD} = 2.2V to 3.6V, V\textsubscript{REF} = V\textsubscript{DD}, V\textsubscript{OVDD} = V\textsubscript{DD}. f\textsubscript{SCLK} = 8MHz, 50% duty cycle, 500ksps; C\textsubscript{DOUT} = 10pF, T\textsubscript{A} = -40°C to +125°C, unless otherwise noted. Typical values are at T\textsubscript{A} = +25°C.) (Note 1)

<table>
<thead>
<tr>
<th>PARAMETER</th>
<th>SYMBOL</th>
<th>CONDITIONS</th>
<th>MIN</th>
<th>TYP</th>
<th>MAX</th>
<th>UNITS</th>
</tr>
</thead>
<tbody>
<tr>
<td><strong>POWER SUPPLY</strong></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Positive Supply Voltage</td>
<td>V\textsubscript{DD}</td>
<td></td>
<td>2.2</td>
<td>3.6</td>
<td>V</td>
<td></td>
</tr>
<tr>
<td>Digital I/O Supply Voltage</td>
<td>V\textsubscript{OVDD}</td>
<td></td>
<td>1.5</td>
<td>V\textsubscript{DD}</td>
<td>V</td>
<td></td>
</tr>
<tr>
<td>Positive Supply Current (Full-Power Mode)</td>
<td>I\textsubscript{VDD}</td>
<td>V\textsubscript{AIN\textsubscript{_}} = V\textsubscript{GND}</td>
<td>1.67</td>
<td></td>
<td>mA</td>
<td></td>
</tr>
<tr>
<td></td>
<td>I\textsubscript{OVDD}</td>
<td>V\textsubscript{AIN\textsubscript{_}} = V\textsubscript{GND}</td>
<td></td>
<td>0.1</td>
<td>mA</td>
<td></td>
</tr>
<tr>
<td>Positive Supply Current (Full-Power Mode), No Clock</td>
<td>I\textsubscript{PD}</td>
<td></td>
<td>1.5</td>
<td></td>
<td>mA</td>
<td></td>
</tr>
<tr>
<td>Power-Down Current</td>
<td></td>
<td>Leakage only</td>
<td></td>
<td>1.3</td>
<td>10</td>
<td>µA</td>
</tr>
<tr>
<td>Line Rejection</td>
<td>V\textsubscript{DD} = 2.2V to 3.6V, V\textsubscript{REF} = 2.2V</td>
<td></td>
<td></td>
<td>0.17</td>
<td></td>
<td>LSB/V</td>
</tr>
</tbody>
</table>

### TIMING CHARACTERISTICS (Note 2)

<table>
<thead>
<tr>
<th>PARAMETER</th>
<th>SYMBOL</th>
<th>CONDITIONS</th>
<th>MIN</th>
<th>TYP</th>
<th>MAX</th>
<th>UNITS</th>
</tr>
</thead>
<tbody>
<tr>
<td>Quiet Time</td>
<td>t\textsubscript{Q}</td>
<td>(Note 3)</td>
<td>4</td>
<td></td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>CS Pulse Width</td>
<td>t\textsubscript{1}</td>
<td>(Note 3)</td>
<td>10</td>
<td></td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>CS Fall to SCLK Setup</td>
<td>t\textsubscript{2}</td>
<td>(Note 3)</td>
<td>5</td>
<td></td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>CS Falling Until DOUT High-Impedance Disabled</td>
<td>t\textsubscript{3}</td>
<td>(Note 3)</td>
<td>1</td>
<td></td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>Data Access Time After SCLK Falling Edge (Figure 2)</td>
<td>t\textsubscript{4}</td>
<td>V\textsubscript{OVDD} = 2.2V to 3.6V</td>
<td>15</td>
<td></td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>V\textsubscript{OVDD} = 1.5V to 2.2V</td>
<td>16.5</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>SCLK Pulse Width Low</td>
<td>t\textsubscript{5}</td>
<td>Percentage of clock period (Note 3)</td>
<td>40</td>
<td>60</td>
<td>%</td>
<td></td>
</tr>
<tr>
<td>SCLK Pulse Width High</td>
<td>t\textsubscript{6}</td>
<td>Percentage of clock period (Note 3)</td>
<td>40</td>
<td>60</td>
<td>%</td>
<td></td>
</tr>
<tr>
<td>Data Hold Time From SCLK Falling Edge</td>
<td>t\textsubscript{7}</td>
<td>Figure 3</td>
<td>5</td>
<td></td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>SCLK Falling Until DOUT High Impedance</td>
<td>t\textsubscript{8}</td>
<td>Figure 4 (Note 3)</td>
<td>2.5</td>
<td>14</td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>Power-Up Time</td>
<td>Conversion cycle (Note 3)</td>
<td></td>
<td></td>
<td>1</td>
<td>Cycle</td>
<td></td>
</tr>
</tbody>
</table>

### DC ACCURACY

<table>
<thead>
<tr>
<th>PARAMETER</th>
<th>SYMBOL</th>
<th>CONDITIONS</th>
<th>MIN</th>
<th>TYP</th>
<th>MAX</th>
<th>UNITS</th>
</tr>
</thead>
<tbody>
<tr>
<td>Resolution</td>
<td></td>
<td></td>
<td>10</td>
<td></td>
<td></td>
<td>Bits</td>
</tr>
<tr>
<td>Integral Nonlinearity</td>
<td>INL</td>
<td></td>
<td></td>
<td>±0.5</td>
<td></td>
<td>LSB</td>
</tr>
<tr>
<td>Differential Nonlinearity</td>
<td>DNL</td>
<td>No missing codes</td>
<td></td>
<td></td>
<td>±0.5</td>
<td></td>
</tr>
<tr>
<td>Offset Error</td>
<td>OE</td>
<td></td>
<td></td>
<td>±0.3</td>
<td>±1.3</td>
<td>LSB</td>
</tr>
<tr>
<td>Gain Error</td>
<td>GE</td>
<td>Excluding offset and reference errors</td>
<td></td>
<td></td>
<td>±0.15</td>
<td>±1.3</td>
</tr>
<tr>
<td>Total Unadjusted Error</td>
<td>TUE</td>
<td></td>
<td></td>
<td>±1</td>
<td></td>
<td>LSB</td>
</tr>
</tbody>
</table>
### ELECTRICAL CHARACTERISTICS (MAX11663) (continued)

(V_{DD} = 2.2V to 3.6V, f_{SCLK} = 8MHz, 50% duty cycle, 500ksps. C_{DOUT} = 10pF, T_{A} = -40°C to +125°C, unless otherwise noted. Typical values are at T_{A} = +25°C.) (Note 1)

<table>
<thead>
<tr>
<th>PARAMETER</th>
<th>SYMBOL</th>
<th>CONDITIONS</th>
<th>MIN</th>
<th>TYP</th>
<th>MAX</th>
<th>UNITS</th>
</tr>
</thead>
<tbody>
<tr>
<td><strong>DYNAMIC PERFORMANCE ( f_{\text{AIN}} = 250\text{kHz} )</strong></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Signal-to-Noise and Distortion</td>
<td>SINAD</td>
<td></td>
<td>60.5</td>
<td>61.5</td>
<td></td>
<td>dB</td>
</tr>
<tr>
<td>Signal-to-Noise Ratio</td>
<td>SNR</td>
<td></td>
<td>60.5</td>
<td>61.5</td>
<td></td>
<td>dB</td>
</tr>
<tr>
<td>Total Harmonic Distortion</td>
<td>THD</td>
<td></td>
<td>-95</td>
<td>-73</td>
<td></td>
<td>dB</td>
</tr>
<tr>
<td>Spurious-Free Dynamic Range</td>
<td>SFDR</td>
<td></td>
<td>75</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Intermodulation Distortion</td>
<td>IMD</td>
<td></td>
<td>f_{1} = 239.8kHz, f_{2} = 200.2kHz</td>
<td>-82</td>
<td></td>
<td>dB</td>
</tr>
<tr>
<td>Full-Power Bandwidth</td>
<td></td>
<td></td>
<td>-3dB point</td>
<td>40</td>
<td></td>
<td>MHz</td>
</tr>
<tr>
<td>Full-Linear Bandwidth</td>
<td></td>
<td></td>
<td>SINAD &gt; 60dB</td>
<td>2.5</td>
<td></td>
<td>MHz</td>
</tr>
<tr>
<td>Small-Signal Bandwidth</td>
<td></td>
<td></td>
<td>45</td>
<td></td>
<td></td>
<td>MHz</td>
</tr>
</tbody>
</table>

### CONVERSION RATE

<table>
<thead>
<tr>
<th>PARAMETER</th>
<th>CONDITION</th>
<th>MIN</th>
<th>TYP</th>
<th>MAX</th>
<th>UNITS</th>
</tr>
</thead>
<tbody>
<tr>
<td>Throughput</td>
<td></td>
<td>5</td>
<td>500</td>
<td></td>
<td>ksps</td>
</tr>
<tr>
<td>Conversion Time</td>
<td></td>
<td>1.56</td>
<td></td>
<td></td>
<td>μs</td>
</tr>
<tr>
<td>Acquisition Time</td>
<td>t_{ACQ}</td>
<td>52</td>
<td></td>
<td></td>
<td>ns</td>
</tr>
<tr>
<td>Aperture Delay</td>
<td>From ( \overline{\text{CS}} ) falling edge</td>
<td>4</td>
<td></td>
<td></td>
<td>ns</td>
</tr>
<tr>
<td>Aperture Jitter</td>
<td></td>
<td>15</td>
<td></td>
<td></td>
<td>ps</td>
</tr>
<tr>
<td>Serial Clock Frequency</td>
<td>f_{CLK}</td>
<td>0.08</td>
<td>8</td>
<td></td>
<td>MHz</td>
</tr>
</tbody>
</table>

### ANALOG INPUT (AIN)

<table>
<thead>
<tr>
<th>PARAMETER</th>
<th>SYMBOL</th>
<th>CONDITION</th>
<th>MIN</th>
<th>TYP</th>
<th>MAX</th>
<th>UNITS</th>
</tr>
</thead>
<tbody>
<tr>
<td>Input Voltage Range</td>
<td>V_{AIN}</td>
<td></td>
<td>0</td>
<td></td>
<td>V_{DD}</td>
<td>V</td>
</tr>
<tr>
<td>Input Leakage Current</td>
<td>I_{ILA}</td>
<td></td>
<td>0.002</td>
<td></td>
<td>±1</td>
<td>μA</td>
</tr>
<tr>
<td>Input Capacitance</td>
<td>C_{AIN}</td>
<td>Track, Hold</td>
<td>20</td>
<td></td>
<td></td>
<td>pF</td>
</tr>
</tbody>
</table>

### DIGITAL INPUTS (SCLK, CS, CHSEL)

<table>
<thead>
<tr>
<th>PARAMETER</th>
<th>SYMBOL</th>
<th>CONDITION</th>
<th>MIN</th>
<th>TYP</th>
<th>MAX</th>
<th>UNITS</th>
</tr>
</thead>
<tbody>
<tr>
<td>Digital Input High Voltage</td>
<td>V_{IH}</td>
<td></td>
<td>0.75</td>
<td></td>
<td>V_{DD}</td>
<td>V</td>
</tr>
<tr>
<td>Digital Input Low Voltage</td>
<td>V_{IL}</td>
<td></td>
<td>0.25</td>
<td></td>
<td>V_{DD}</td>
<td>V</td>
</tr>
<tr>
<td>Digital Input Hysteresis</td>
<td>V_{HYST}</td>
<td></td>
<td>0.15</td>
<td></td>
<td>V_{DD}</td>
<td>V</td>
</tr>
<tr>
<td>Digital Input Leakage Current</td>
<td>I_{IL}</td>
<td>Inputs at GND or V_{DD}</td>
<td>0.001</td>
<td></td>
<td>±1</td>
<td>μA</td>
</tr>
<tr>
<td>Digital Input Capacitance</td>
<td>C_{IN}</td>
<td></td>
<td>2</td>
<td></td>
<td></td>
<td>pF</td>
</tr>
</tbody>
</table>
## 500ksps, Low-Power, Serial 12-/10-/8-Bit ADCs

### ELECTRICAL CHARACTERISTICS (MAX11663) (continued)

(V\(_{DD}\) = 2.2V to 3.6V, \(f_{SCLK} = 8\)MHz, 50% duty cycle, 500ksps. \(C_{DOUT} = 10\)pF, \(T_A = -40^\circ C\) to +125\(^\circ C\), unless otherwise noted. Typical values are at \(T_A = +25^\circ C\).) (Note 1)

### DIGITAL OUTPUT (DOUT)

<table>
<thead>
<tr>
<th>PARAMETER</th>
<th>SYMBOL</th>
<th>CONDITIONS</th>
<th>MIN</th>
<th>TYP</th>
<th>MAX</th>
<th>UNITS</th>
</tr>
</thead>
<tbody>
<tr>
<td>Digital Output Voltage</td>
<td>(V_{OH})</td>
<td>(I_{SOURCE} = 200\mu A)</td>
<td>(0.85 \times V_{DD})</td>
<td></td>
<td></td>
<td>V</td>
</tr>
<tr>
<td>Digital Output Voltage</td>
<td>(V_{OL})</td>
<td>(I_{SINK} = 200\mu A)</td>
<td>(0.15 \times V_{DD})</td>
<td></td>
<td></td>
<td>V</td>
</tr>
<tr>
<td>High-Impedance Leakage Current</td>
<td>(I_{OL})</td>
<td></td>
<td></td>
<td>(\pm 1.0)</td>
<td></td>
<td>(\mu A)</td>
</tr>
<tr>
<td>High-Impedance Output Capacitance</td>
<td>(C_{OUT})</td>
<td></td>
<td></td>
<td>4</td>
<td></td>
<td>pF</td>
</tr>
</tbody>
</table>

### POWER SUPPLY

<table>
<thead>
<tr>
<th>PARAMETER</th>
<th>SYMBOL</th>
<th>CONDITIONS</th>
<th>MIN</th>
<th>TYP</th>
<th>MAX</th>
<th>UNITS</th>
</tr>
</thead>
<tbody>
<tr>
<td>Positive Supply Voltage</td>
<td>(V_{DD})</td>
<td></td>
<td>2.2</td>
<td>3.6</td>
<td></td>
<td>V</td>
</tr>
<tr>
<td>Positive Supply Current (Full-Power Mode)</td>
<td>(I_{VDD})</td>
<td>(V_{AIN} = V_{GND})</td>
<td></td>
<td></td>
<td>1.76</td>
<td>mA</td>
</tr>
<tr>
<td>Positive Supply Current (Full-Power Mode), No Clock</td>
<td>(I_{VDD})</td>
<td></td>
<td></td>
<td></td>
<td>1.48</td>
<td>mA</td>
</tr>
<tr>
<td>Power-Down Current</td>
<td>(I_{PD})</td>
<td>Leakage only</td>
<td>1.3</td>
<td>10</td>
<td></td>
<td>(\mu A)</td>
</tr>
<tr>
<td>Line Rejection</td>
<td></td>
<td>(V_{DD} = 2.2V) to (3.6V)</td>
<td></td>
<td></td>
<td>0.17</td>
<td>LSB/V</td>
</tr>
</tbody>
</table>

### TIMING CHARACTERISTICS (Note 2)

<table>
<thead>
<tr>
<th>PARAMETER</th>
<th>SYMBOL</th>
<th>CONDITIONS</th>
<th>MIN</th>
<th>TYP</th>
<th>MAX</th>
<th>UNITS</th>
</tr>
</thead>
<tbody>
<tr>
<td>Quiet Time</td>
<td>(t_Q)</td>
<td>(Note 3)</td>
<td></td>
<td>4</td>
<td></td>
<td>ns</td>
</tr>
<tr>
<td>CS Pulse Width</td>
<td>(t_1)</td>
<td>(Note 3)</td>
<td></td>
<td>10</td>
<td></td>
<td>ns</td>
</tr>
<tr>
<td>CS Fall to SCLK Setup</td>
<td>(t_2)</td>
<td>(Note 3)</td>
<td></td>
<td>5</td>
<td></td>
<td>ns</td>
</tr>
<tr>
<td>CS Falling Until DOUT High-Impedance Disabled</td>
<td>(t_3)</td>
<td>(Note 3)</td>
<td></td>
<td>1</td>
<td></td>
<td>ns</td>
</tr>
<tr>
<td>Data Access Time After SCLK Falling Edge</td>
<td>(t_4)</td>
<td>Figure 2, (V_{DD} = 2.2V) to (3.6V)</td>
<td></td>
<td>15</td>
<td></td>
<td>ns</td>
</tr>
<tr>
<td>SCLK Pulse Width Low</td>
<td>(t_5)</td>
<td>Percentage of clock period (Note 3)</td>
<td>40</td>
<td>60</td>
<td></td>
<td>%</td>
</tr>
<tr>
<td>SCLK Pulse Width High</td>
<td>(t_6)</td>
<td>Percentage of clock period (Note 3)</td>
<td>40</td>
<td>60</td>
<td></td>
<td>%</td>
</tr>
<tr>
<td>Data Hold Time From SCLK Falling Edge</td>
<td>(t_7)</td>
<td>Figure 3</td>
<td></td>
<td>5</td>
<td></td>
<td>ns</td>
</tr>
<tr>
<td>SCLK Falling Until DOUT High Impedance</td>
<td>(t_8)</td>
<td>Figure 4 (Note 3)</td>
<td></td>
<td>2.5</td>
<td>14</td>
<td>ns</td>
</tr>
<tr>
<td>Power-Up Time</td>
<td></td>
<td>Conversion cycle (Note 3)</td>
<td></td>
<td></td>
<td>1</td>
<td>Cycle</td>
</tr>
</tbody>
</table>

---

**MAXIM**

10
500ksps, Low-Power, Serial 12-/10-/8-Bit ADCs

ELECTRICAL CHARACTERISTICS (MAX11662)

(VDD = 2.2V to 3.6V, VREF = VDD, VOVDD = VDD, fSCLK = 8MHz, 50% duty cycle, 500ksps, COUT = 10pF, TA = -40°C to +125°C, unless otherwise noted. Typical values are at TA = +25°C.) (Note 1)

<table>
<thead>
<tr>
<th>PARAMETER</th>
<th>SYMBOL</th>
<th>CONDITIONS</th>
<th>MIN</th>
<th>TYP</th>
<th>MAX</th>
<th>UNITS</th>
</tr>
</thead>
<tbody>
<tr>
<td>DC ACCURACY</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Resolution</td>
<td></td>
<td></td>
<td>8</td>
<td></td>
<td></td>
<td>Bits</td>
</tr>
<tr>
<td>Integral Nonlinearity</td>
<td>INL</td>
<td></td>
<td>±0.25LSB</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Differential Nonlinearity</td>
<td>DNL</td>
<td>No missing codes</td>
<td>±0.25LSB</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Offset Error</td>
<td>OE</td>
<td></td>
<td>0.45 ±0.8LSB</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Gain Error</td>
<td>GE</td>
<td>Excluding offset and reference errors</td>
<td>0 ±0.25LSB</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Total Unadjusted Error</td>
<td>TUE</td>
<td></td>
<td>0.5</td>
<td></td>
<td></td>
<td>LSB</td>
</tr>
<tr>
<td>Channel-to-Channel Offset Matching</td>
<td></td>
<td></td>
<td>0.01</td>
<td></td>
<td></td>
<td>LSB</td>
</tr>
<tr>
<td>Channel-to-Channel Gain Matching</td>
<td></td>
<td></td>
<td>0.01</td>
<td></td>
<td></td>
<td>LSB</td>
</tr>
<tr>
<td>DYNAMIC PERFORMANCE (fAIN = 250kHz)</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Signal-to-Noise and Distortion</td>
<td>SINAD</td>
<td></td>
<td>49</td>
<td>49.7</td>
<td></td>
<td>dB</td>
</tr>
<tr>
<td>Signal-to-Noise Ratio</td>
<td>SNR</td>
<td></td>
<td>49</td>
<td>49.7</td>
<td></td>
<td>dB</td>
</tr>
<tr>
<td>Total Harmonic Distortion</td>
<td>THD</td>
<td></td>
<td>-75</td>
<td>-67</td>
<td></td>
<td>dB</td>
</tr>
<tr>
<td>Spurious-Free Dynamic Range</td>
<td>SFDR</td>
<td></td>
<td>63</td>
<td>67</td>
<td></td>
<td>dB</td>
</tr>
<tr>
<td>Intermodulation Distortion</td>
<td>IMD</td>
<td></td>
<td>-65</td>
<td></td>
<td></td>
<td>dB</td>
</tr>
<tr>
<td>Full-Power Bandwidth</td>
<td></td>
<td></td>
<td>40</td>
<td></td>
<td></td>
<td>MHz</td>
</tr>
<tr>
<td>Full-Linear Bandwidth</td>
<td></td>
<td></td>
<td>2.5</td>
<td></td>
<td></td>
<td>MHz</td>
</tr>
<tr>
<td>Small-Signal Bandwidth</td>
<td></td>
<td></td>
<td>45</td>
<td></td>
<td></td>
<td>MHz</td>
</tr>
<tr>
<td>Crosstalk</td>
<td></td>
<td></td>
<td>-90</td>
<td></td>
<td></td>
<td>dB</td>
</tr>
<tr>
<td>CONVERSION RATE</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Throughput</td>
<td></td>
<td></td>
<td>5</td>
<td>500</td>
<td></td>
<td>kps</td>
</tr>
<tr>
<td>Conversion Time</td>
<td></td>
<td></td>
<td>1.56</td>
<td></td>
<td></td>
<td>µs</td>
</tr>
<tr>
<td>Acquisition Time</td>
<td></td>
<td></td>
<td>52</td>
<td></td>
<td></td>
<td>ns</td>
</tr>
<tr>
<td>Aperture Delay</td>
<td></td>
<td></td>
<td>4</td>
<td></td>
<td></td>
<td>ns</td>
</tr>
<tr>
<td>Aperture Jitter</td>
<td></td>
<td></td>
<td>15</td>
<td></td>
<td></td>
<td>ps</td>
</tr>
<tr>
<td>Serial-Clock Frequency</td>
<td></td>
<td></td>
<td>0.08</td>
<td>8</td>
<td></td>
<td>MHz</td>
</tr>
<tr>
<td>ANALOG INPUT (AIN1, AIN2)</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Input Voltage Range</td>
<td>VAIN_</td>
<td></td>
<td>0</td>
<td></td>
<td>VREF</td>
<td>V</td>
</tr>
<tr>
<td>Input Leakage Current</td>
<td>ILA</td>
<td></td>
<td>0.002</td>
<td>±1</td>
<td></td>
<td>µA</td>
</tr>
<tr>
<td>Input Capacitance</td>
<td>CAIN_</td>
<td></td>
<td>20</td>
<td></td>
<td></td>
<td>pF</td>
</tr>
<tr>
<td></td>
<td></td>
<td>Track</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>Hold</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>EXTERNAL REFERENCE INPUT (REF)</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Reference Input Voltage Range</td>
<td>VREF</td>
<td></td>
<td>1</td>
<td></td>
<td>VDD + 0.05</td>
<td>V</td>
</tr>
<tr>
<td>Reference Input Leakage Current</td>
<td>ILR</td>
<td>Conversion stopped</td>
<td>0.005</td>
<td>±1</td>
<td></td>
<td>µA</td>
</tr>
<tr>
<td>Reference Input Capacitance</td>
<td>CREF</td>
<td></td>
<td>5</td>
<td></td>
<td></td>
<td>pF</td>
</tr>
</tbody>
</table>
## 500ksps, Low-Power, Serial 12-/10-/8-Bit ADCs

ELECTRICAL CHARACTERISTICS (MAX11662) (continued)

(V<sub>DD</sub> = 2.2V to 3.6V, V<sub>REF</sub> = V<sub>DD</sub>, V<sub>OVDD</sub> = V<sub>DD</sub>, f<sub>SCLK</sub> = 8MHz, 50% duty cycle, 500ksps, C<sub>DOUT</sub> = 10pF, TA = -40°C to +125°C, unless otherwise noted. Typical values are at TA = +25°C.) (Note 1)

### DIGITAL INPUTS (SCLK, CS)

<table>
<thead>
<tr>
<th>PARAMETER</th>
<th>SYMBOL</th>
<th>CONDITIONS</th>
<th>MIN</th>
<th>TYP</th>
<th>MAX</th>
<th>UNITS</th>
</tr>
</thead>
<tbody>
<tr>
<td>Digital Input High Voltage</td>
<td>V&lt;sub&gt;IH&lt;/sub&gt;</td>
<td></td>
<td>0.75 x V&lt;sub&gt;OVDD&lt;/sub&gt;</td>
<td>V</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Digital Input Low Voltage</td>
<td>V&lt;sub&gt;IL&lt;/sub&gt;</td>
<td></td>
<td>0.25 x V&lt;sub&gt;OVDD&lt;/sub&gt;</td>
<td>V</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Digital Input Hysteresis</td>
<td>V&lt;sub&gt;HYST&lt;/sub&gt;</td>
<td></td>
<td>0.15 x V&lt;sub&gt;OVDD&lt;/sub&gt;</td>
<td>V</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Digital Input Leakage Current</td>
<td>I&lt;sub&gt;IL&lt;/sub&gt;</td>
<td>Inputs at GND or V&lt;sub&gt;DD&lt;/sub&gt;</td>
<td>0.001 ±1 µA</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Digital Input Capacitance</td>
<td>C&lt;sub&gt;IN&lt;/sub&gt;</td>
<td></td>
<td>2</td>
<td>pF</td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

### DIGITAL OUTPUT (DOUT)

<table>
<thead>
<tr>
<th>PARAMETER</th>
<th>SYMBOL</th>
<th>CONDITIONS</th>
<th>MIN</th>
<th>TYP</th>
<th>MAX</th>
<th>UNITS</th>
</tr>
</thead>
<tbody>
<tr>
<td>Output High Voltage</td>
<td>V&lt;sub&gt;OH&lt;/sub&gt;</td>
<td>ISOURCE = 200µA (Note 3)</td>
<td>0.85 x V&lt;sub&gt;OVDD&lt;/sub&gt;</td>
<td>V</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Output Low Voltage</td>
<td>V&lt;sub&gt;OL&lt;/sub&gt;</td>
<td>ISINK = 200µA (Note 3)</td>
<td>0.15 x V&lt;sub&gt;OVDD&lt;/sub&gt;</td>
<td>V</td>
<td></td>
<td></td>
</tr>
<tr>
<td>High-Impedance Leakage Current</td>
<td>I&lt;sub&gt;OL&lt;/sub&gt;</td>
<td></td>
<td>±1.0</td>
<td>µA</td>
<td></td>
<td></td>
</tr>
<tr>
<td>High-Impedance Output Capacitance</td>
<td>C&lt;sub&gt;OUT&lt;/sub&gt;</td>
<td></td>
<td>4</td>
<td>pF</td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

### POWER SUPPLY

<table>
<thead>
<tr>
<th>PARAMETER</th>
<th>SYMBOL</th>
<th>CONDITIONS</th>
<th>MIN</th>
<th>TYP</th>
<th>MAX</th>
<th>UNITS</th>
</tr>
</thead>
<tbody>
<tr>
<td>Positive Supply Voltage</td>
<td>V&lt;sub&gt;DD&lt;/sub&gt;</td>
<td></td>
<td>2.2</td>
<td>3.6</td>
<td>V</td>
<td></td>
</tr>
<tr>
<td>Digital I/O Supply Voltage</td>
<td>V&lt;sub&gt;OVDD&lt;/sub&gt;</td>
<td></td>
<td>1.5</td>
<td></td>
<td>V</td>
<td></td>
</tr>
<tr>
<td>Positive Supply Current (Full-Power Mode)</td>
<td>I&lt;sub&gt;VDD&lt;/sub&gt;</td>
<td>V&lt;sub&gt;AIN&lt;/sub&gt; = V&lt;sub&gt;GND&lt;/sub&gt;</td>
<td>1.67</td>
<td></td>
<td>mA</td>
<td></td>
</tr>
<tr>
<td></td>
<td>I&lt;sub&gt;OVDD&lt;/sub&gt;</td>
<td>V&lt;sub&gt;AIN&lt;/sub&gt; = V&lt;sub&gt;GND&lt;/sub&gt;</td>
<td>0.1</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Positive Supply Current (Full-Power Mode), No Clock</td>
<td>I&lt;sub&gt;VDD&lt;/sub&gt;</td>
<td></td>
<td>1.5</td>
<td></td>
<td>mA</td>
<td></td>
</tr>
<tr>
<td>Power-Down Current</td>
<td>I&lt;sub&gt;PD&lt;/sub&gt;</td>
<td>Leakage only</td>
<td>1.3</td>
<td>10</td>
<td>µA</td>
<td></td>
</tr>
<tr>
<td>Line Rejection</td>
<td>V&lt;sub&gt;DD&lt;/sub&gt;</td>
<td>V&lt;sub&gt;DD&lt;/sub&gt; = 2.2V to 3.6V, V&lt;sub&gt;REF&lt;/sub&gt; = 2.2V</td>
<td>0.17</td>
<td></td>
<td>LSB/V</td>
<td></td>
</tr>
</tbody>
</table>

### TIMING CHARACTERISTICS (Note 2)

<table>
<thead>
<tr>
<th>PARAMETER</th>
<th>SYMBOL</th>
<th>CONDITIONS</th>
<th>MIN</th>
<th>TYP</th>
<th>MAX</th>
<th>UNITS</th>
</tr>
</thead>
<tbody>
<tr>
<td>Quiet Time</td>
<td>t&lt;sub&gt;Q&lt;/sub&gt;</td>
<td>(Note 3)</td>
<td>4</td>
<td></td>
<td></td>
<td>ns</td>
</tr>
<tr>
<td>CS Pulse Width</td>
<td>t&lt;sub&gt;1&lt;/sub&gt;</td>
<td>(Note 3)</td>
<td>10</td>
<td></td>
<td></td>
<td>ns</td>
</tr>
<tr>
<td>CS Fall to SCLK Setup</td>
<td>t&lt;sub&gt;2&lt;/sub&gt;</td>
<td>(Note 3)</td>
<td>5</td>
<td></td>
<td></td>
<td>ns</td>
</tr>
<tr>
<td>CS Falling Until DOUT High-Impedance Disabled</td>
<td>t&lt;sub&gt;3&lt;/sub&gt;</td>
<td>(Note 3)</td>
<td>1</td>
<td></td>
<td></td>
<td>ns</td>
</tr>
<tr>
<td>Data Access Time After SCLK Falling Edge (Figure 2)</td>
<td>t&lt;sub&gt;4&lt;/sub&gt;</td>
<td>V&lt;sub&gt;OVDD&lt;/sub&gt; = 2.2V to 3.6V (Note 3)</td>
<td>15</td>
<td></td>
<td></td>
<td>ns</td>
</tr>
<tr>
<td></td>
<td></td>
<td>V&lt;sub&gt;OVDD&lt;/sub&gt; = 1.5V to 2.2V (Note 3)</td>
<td>16.5</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>SCLK Pulse Width Low</td>
<td>t&lt;sub&gt;5&lt;/sub&gt;</td>
<td>Percentage of clock period</td>
<td>40</td>
<td>60</td>
<td>%</td>
<td></td>
</tr>
<tr>
<td>SCLK Pulse Width High</td>
<td>t&lt;sub&gt;6&lt;/sub&gt;</td>
<td>Percentage of clock period</td>
<td>40</td>
<td>60</td>
<td>%</td>
<td></td>
</tr>
<tr>
<td>Data Hold Time From SCLK Falling Edge</td>
<td>t&lt;sub&gt;7&lt;/sub&gt;</td>
<td>Figure 3</td>
<td>5</td>
<td></td>
<td></td>
<td>ns</td>
</tr>
<tr>
<td>SCLK Falling Until DOUT High Impedance</td>
<td>t&lt;sub&gt;8&lt;/sub&gt;</td>
<td>Figure 4 (Note 3)</td>
<td>2.5</td>
<td>14</td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>Power-Up Time</td>
<td></td>
<td>Conversion cycle (Note 3)</td>
<td>1</td>
<td></td>
<td>Cycle</td>
<td></td>
</tr>
</tbody>
</table>
ELECTRICAL CHARACTERISTICS (MAX11661)
(V_{DD} = 2.2V to 3.6V, \text{fsCLK} = 8MHz, 50% duty cycle, 500ksps. \text{C}_{\text{DOUT}} = 10pF, T_{A} = -40^\circ\text{C} to +125^\circ\text{C}, unless otherwise noted. Typical values are at \text{T}_{A} = +25^\circ\text{C}.)(Note 1)

<table>
<thead>
<tr>
<th>PARAMETER</th>
<th>SYMBOL</th>
<th>CONDITIONS</th>
<th>MIN</th>
<th>TYP</th>
<th>MAX</th>
<th>UNITS</th>
</tr>
</thead>
<tbody>
<tr>
<td>DC ACCURACY</td>
<td>Resolution</td>
<td>INL</td>
<td>8</td>
<td>8 BITS</td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td>Integral Nonlinearity</td>
<td>DNL</td>
<td>No missing codes</td>
<td>±0.25</td>
<td>LSB</td>
<td></td>
</tr>
<tr>
<td></td>
<td>Offset Error</td>
<td>OE</td>
<td>0.45</td>
<td>0.8</td>
<td>LSB</td>
<td></td>
</tr>
<tr>
<td></td>
<td>Gain Error</td>
<td>GE</td>
<td>Excluding offset and reference errors</td>
<td>±0.04</td>
<td>±0.5</td>
<td>LSB</td>
</tr>
<tr>
<td></td>
<td>Total Unadjusted Error</td>
<td>TUE</td>
<td>±0.75</td>
<td>LSB</td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

| DYNAMIC PERFORMANCE (f_{AIN} = 250kHz) | Signal-to-Noise and Distortion | SINAD | 49 | -49.5 | dB |
| | Signal-to-Noise Ratio | SNR | 49 | 49.5 | dB |
| | Total Harmonic Distortion | THD | -70 | -67 | dB |
| | Spurious-Free Dynamic Range | SFDR | 63 | 66 | dB |
| | Intermodulation Distortion | IMD | f_1 = 239.8kHz, f_2 = 200.3kHz | -65 | dB |
| | Full-Power Bandwidth | -3dB point | 40 | MHz |
| | Full-Linear Bandwidth | SINAD > 49dB | 2.5 | MHz |
| | Small-Signal Bandwidth | | 45 | MHz |

| CONVERSION RATE | Throughput | 5 | 500 | ksps |
| | Conversion Time | 1.56 | μs |
| | Acquisition Time | t_{ACQ} | 52 | ns |
| | Aperture Delay | From CS falling edge | 4 | ns |
| | Aperture Jitter | | 15 | ps |
| | Serial-Clock Frequency | f_{CLK} | 0.08 | 8 | MHz |

| ANALOG INPUT (AIN) | Input Voltage Range | V_{AIN} | 0 | V_{DD} |
| | Input Leakage Current | I_{ILA} | 0.002 | ±1 | μA |
| | Input Capacitance | C_{AIN} | Track | 20 | pF |
| | | | Hold | 4 | |

| DIGITAL INPUTS (SCLK, CS) | Digital Input High Voltage | V_{IH} | 0.75 x | V_{DD} |
| | Digital Input Low Voltage | V_{IL} | 0.25 x | V_{DD} |
| | Digital Input Hysteresis | V_{HYST} | 0.15 | V_{DD} |
| | Digital Input Leakage Current | I_{IL} | Inputs at GND or V_{DD} | 0.001 | ±1 | μA |
| | Digital Input Capacitance | C_{IN} | 2 | pF |
500ksps, Low-Power, Serial 12-/10-/8-Bit ADCs

ELECTRICAL CHARACTERISTICS (MAX11661) (continued)

(VDD = 2.2V to 3.6V, fSCLK = 8MHz, 50% duty cycle, 500ksps. C DOUT = 10pF, TA = -40°C to +125°C, unless otherwise noted. Typical values are at TA = +25°C.) (Note 1)

<table>
<thead>
<tr>
<th>PARAMETER</th>
<th>SYMBOL</th>
<th>CONDITIONS</th>
<th>MIN</th>
<th>TYP</th>
<th>MAX</th>
<th>UNITS</th>
</tr>
</thead>
<tbody>
<tr>
<td>DIGITAL OUTPUT (DOUT)</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Output High Voltage</td>
<td>VOH</td>
<td>ISOURCE = 200µA</td>
<td></td>
<td></td>
<td>0.85 x</td>
<td>V</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td>V DDD</td>
<td></td>
</tr>
<tr>
<td>Output Low Voltage</td>
<td>VOL</td>
<td>ISINK = 200µA</td>
<td>0.15 x</td>
<td></td>
<td></td>
<td>µA</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>V DDD</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>High-Impedance Leakage</td>
<td>IOL</td>
<td></td>
<td>±1.0</td>
<td></td>
<td></td>
<td>µA</td>
</tr>
<tr>
<td>Capacitance</td>
<td>COUT</td>
<td></td>
<td>4</td>
<td></td>
<td></td>
<td>pF</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>POWER SUPPLY</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Positive Supply Voltage</td>
<td>VDD</td>
<td></td>
<td>2.2</td>
<td></td>
<td>3.6</td>
<td>V</td>
</tr>
<tr>
<td>Positive Supply Current</td>
<td>IVDD</td>
<td>VAIN = VGND</td>
<td>1.76</td>
<td></td>
<td></td>
<td>mA</td>
</tr>
<tr>
<td>(Full-Power Mode)</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Positive Supply Current</td>
<td>IVDD</td>
<td></td>
<td>1.48</td>
<td></td>
<td></td>
<td>mA</td>
</tr>
<tr>
<td>(Full-Power Mode), No Clock</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Power-Down Current</td>
<td>IPD</td>
<td>Leakage only</td>
<td>1.3</td>
<td></td>
<td>10</td>
<td>µA</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>TIMING CHARACTERISTICS (Note 2)</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Quiet Time</td>
<td>tQ</td>
<td></td>
<td>4</td>
<td></td>
<td></td>
<td>ns</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>CS Pulse Width</td>
<td>t1</td>
<td></td>
<td>10</td>
<td></td>
<td></td>
<td>ns</td>
</tr>
<tr>
<td>CS Fall to SCLK Setup</td>
<td>t2</td>
<td></td>
<td>5</td>
<td></td>
<td></td>
<td>ns</td>
</tr>
<tr>
<td>CS Falling Until DOUT High-</td>
<td>t3</td>
<td></td>
<td>1</td>
<td></td>
<td></td>
<td>ns</td>
</tr>
<tr>
<td>Impedance Disabled</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Data Access Time After SCLK</td>
<td>t4</td>
<td>Figure 2, VDD = 2.2V to 3.6V</td>
<td></td>
<td></td>
<td>15</td>
<td>ns</td>
</tr>
<tr>
<td>Falling Edge</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>SCLK Pulse Width Low</td>
<td>t5</td>
<td>Percentage of clock period (Note 3)</td>
<td>40</td>
<td>60</td>
<td></td>
<td>%</td>
</tr>
<tr>
<td>SCLK Pulse Width High</td>
<td>t6</td>
<td>Percentage of clock period (Note 3)</td>
<td>40</td>
<td>60</td>
<td></td>
<td>%</td>
</tr>
<tr>
<td>Data Hold Time From SCLK</td>
<td>t7</td>
<td>Figure 3</td>
<td>5</td>
<td></td>
<td></td>
<td>ns</td>
</tr>
<tr>
<td>Falling Edge</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>SCLK Falling Until DOUT High</td>
<td>t8</td>
<td>Figure 4 (Note 3)</td>
<td>2.5</td>
<td></td>
<td>14</td>
<td>ns</td>
</tr>
<tr>
<td>Impedance</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Power-Up Time</td>
<td></td>
<td>Conversion cycle (Note 3)</td>
<td>1</td>
<td></td>
<td></td>
<td>Cycle</td>
</tr>
</tbody>
</table>

Note 1: Limits at TA = -40°C are guaranteed by design and not production tested.
Note 2: All timing specifications given are with a 10pF capacitor.
Note 3: Guaranteed by design in characterization; not production tested.
500ksps, Low-Power, Serial 12-/10-/8-Bit ADCs

**Figure 1. Interface Signals for Maximum Throughput, 12-Bit Devices**

**Figure 2. Setup Time After SCLK Falling Edge**

**Figure 3. Hold Time After SCLK Falling Edge**

**Figure 4. SCLK Falling Edge DOUT Three-State**
500ksps, Low-Power, Serial 12-/10-/8-Bit ADCs

Typical Operating Characteristics

(MAX11665AUT+, TA = +25°C, unless otherwise noted.)

SOT23 TYPICAL OPERATING CHARACTERISTICS

INTEGRAL NONLINEARITY (INL) vs. OUTPUT CODE

DIFFERENTIAL NONLINEARITY (DNL) vs. OUTPUT CODE

OFFSET ERROR vs. TEMPERATURE

THD vs. ANALOG INPUT FREQUENCY

GAIN ERROR vs. TEMPERATURE

SIGNAL-TO-NOISE RATIO (SNR) vs. ANALOG INPUT FREQUENCY

SPURIOUS-FREE DYNAMIC RANGE (SFDR) vs. ANALOG INPUT FREQUENCY
Typical Operating Characteristics (continued)

SOT23 TYPICAL OPERATING CHARACTERISTICS

![Graph of Supply Current vs. Temperature](image)

**SUPPLY CURRENT vs. TEMPERATURE**

- **VDD = 3.6V**
- **VDD = 3V**
- **VDD = 2.2V**

![Graph of Signal-to-Noise and Distortion Ratio vs. Analog Input Frequency](image)

**SIGNAL-TO-NOISE AND DISTORTION RATIO (SINAD) vs. ANALOG INPUT FREQUENCY**

- **fIN (kHz)**: 0, 50, 100, 150, 200, 250
- **SINAD (dB)**: 70, 72, 74, 76

![Histogram for 30,000 Conversions](image)

**HISTOGRAM FOR 30,000 CONVERSIONS**

- **Digital Code Output**: 2046, 2047, 2048, 2049, 2050
- **Code Count**: 0, 5000, 10,000, 15,000, 20,000, 25,000, 30,000, 35,000

![Graph of Signal-to-Noise Ratio (SNR) vs. Supply Voltage (VDD)](image)

**SIGNAL-TO-NOISE RATIO (SNR) vs. SUPPLY VOLTAGE (VDD)**

- **VDD (V)**: 2.2, 2.4, 2.6, 2.8, 3.0, 3.2, 3.4, 3.6
- **SNR (dB)**: 71, 72, 73, 74, 75

![Graph of THD vs. Input Resistance](image)

**THD vs. INPUT RESISTANCE**

- **fS = 500ksps**
- **fIN = 250kHz**
- **RIN (Ω)**: 0, 10, 20, 30, 40, 50, 60, 70, 80, 90, 100
- **THD (dB)**: -75, -73, -71, -70, -69, -68, -67

**100kHz SINE-WAVE INPUT**

- **fIN = 99.4kHz**
- **fS = 500ksps**
- **VDD = 3V**
- **AHD2 = -88dB**
**500ksps, Low-Power, Serial 12-/10-/8-Bit ADCs**

**Pin Description**

<table>
<thead>
<tr>
<th>PIN</th>
<th>NAME</th>
<th>FUNCTION</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>AIN1</td>
<td>Analog Input Channel 1. Single-ended analog input with respect to AGND with range of 0V to VREF.</td>
</tr>
<tr>
<td>2</td>
<td>AIN2</td>
<td>Analog Input Channel 2. Single-ended analog input with respect to AGND with range of 0V to VREF.</td>
</tr>
<tr>
<td>—</td>
<td>GND</td>
<td>Ground. Connect GND to the GND ground plane.</td>
</tr>
<tr>
<td>—</td>
<td>AGND</td>
<td>Analog Ground. Connect AGND directly to the GND ground plane.</td>
</tr>
<tr>
<td>4</td>
<td>REF</td>
<td>External Reference Input. REF defines the signal range of the input signal AIN1/AIN2: 0V to VREF. The range of VREF is 1V to VDD. Bypass REF to AGND with 10μF</td>
</tr>
<tr>
<td>5</td>
<td>VDD</td>
<td>Positive Supply Voltage. Bypass VDD with a 10μF</td>
</tr>
<tr>
<td>6</td>
<td>CHSEL</td>
<td>Channel Select. Set CHSEL high to select AIN2 for conversion. Set CHSEL low to select AIN1 for conversion.</td>
</tr>
<tr>
<td>7</td>
<td>OVDD</td>
<td>Digital Interface Supply for SCLK, CS, DOUT, and CHSEL. The OVDD range is 1.5V to VDD. Bypass OVDD with a 10μF</td>
</tr>
<tr>
<td>8</td>
<td>DOUT</td>
<td>Three-State Serial-Data Output. ADC conversion results are clocked out on the falling edge of SCLK, MSB first. See Figure 1.</td>
</tr>
<tr>
<td>9</td>
<td>SCLK</td>
<td>Serial-Clock Input. SCLK drives the conversion process. DOUT is updated on the falling edge of SCLK. See Figures 2 and 3.</td>
</tr>
<tr>
<td>—</td>
<td>EP</td>
<td>Exposed Pad (µMAX Only). Connect EP directly to a solid ground plane. Devices do not operate when EP is not connected to ground!</td>
</tr>
</tbody>
</table>
500ksps, Low-Power, Serial 12-/10-/8-Bit ADCs

Functional Diagrams

Typical Operating Circuit
**500ksps, Low-Power, Serial 12-/10-/8-Bit ADCs**

**Detailed Description**

The MAX11661–MAX11666 are fast, 12-/10-/8-bit, low-power, single-supply ADCs. The devices operate from a 2.2V to 3.6V supply and consume only 2.98mW (VDD = 2.2V) or 4.37mW (VDD = 3V). These devices are capable of sampling at full rate when driven by an 8MHz clock. The dual-channel devices provide a separate digital supply input (OVDD) to power the digital interface enabling communication with 1.5V, 1.8V, 2.5V, or 3V digital systems.

The conversion result appears at DOUT, MSB first, with a leading zero followed by the 12-bit, 10-bit, or 8-bit result. A 12-bit result is followed by two trailing zeros, a 10-bit result is followed by four trailing zeros, and an 8-bit result is followed by six trailing zeros. See Figures 1 and 5.

The dual-channel devices feature a dedicated reference input (REF). The input signal range for AIN1/AIN2 is defined as 0V to VREF with respect to AGND. The single-channel devices use VDD as the reference. The input signal range of AIN is defined as 0V to VDD with respect to GND.

These ADCs include a power-down feature allowing minimized power consumption at 2.5µA/ksp for lower throughput rates. The wake-up and power-down feature is controlled by using the SPI interface as described in the Operating Modes section.

**Serial Interface**

The devices feature a 3-wire serial interface that directly connects to SPI, QSPI, and MICROWIRE devices without external logic. Figures 1 and 5 show the interface signals for a single conversion frame to achieve maximum throughput.

The falling edge of CS defines the sampling instant. Once CS transitions low, the external clock signal (SCLK) controls the conversion.

The SAR core successively extracts binary-weighted bits in every clock cycle. The MSB appears on the data bus during the 2nd clock cycle with a delay outlined in the timing specifications. All extracted data bits appear successively on the data bus with the LSB appearing during the 13th/11th/9th clock cycle for 12-/10-/8-bit operation. The serial data stream of conversion bits is preceded by a leading “zero” and succeeded by trailing “zeros.” The data output (DOUT) goes into a high-impedance state during the 16th clock cycle.

![Figure 5. 10-/8-Bit Timing Diagrams](image-url)
To sustain the maximum sample rate, all devices have to be resampled immediately after the 16th clock cycle. For lower sample rates, the CS falling edge can be delayed leaving DOUT in a high-impedance condition. Pull CS high after the 10th SCLK falling edge (see the Operating Modes section).

**Analog Input**

The devices produce a digital output that corresponds to the analog input within the specified operating range of 0V to VREF for the dual-channel devices and 0V to VDD for the single-channel devices.

Figure 6 shows an equivalent circuit for the analog input AIN (for single-channel devices) and AIN1/AIN2 (for dual-channel devices). Internal protection diodes D1/D2 confine the analog input voltage within the power rails (VDD, GND). The analog input voltage can swing from GND - 0.3V to VDD + 0.3V without damaging the device.

The electric load presented to the external stage driving the analog input varies depending on which mode the ADC is in: track mode vs. conversion mode. In track mode, the internal sampling capacitor Cₛ (16pF) has to be charged through the resistor R (R = 50Ω) to the input voltage. For faithful sampling of the input, the capacitor voltage on Cₛ has to settle to the required accuracy during the track time.

**ADC Transfer Function**

The output format is straight binary. The code transitions midway between successive integer LSB values such as 0.5 LSB, 1.5 LSB, etc. The LSB size for single-channel devices is VDD/2ⁿ and for dual-channel devices is VREF/2ⁿ, where n is the resolution. The ideal transfer characteristic is shown in Figure 10.

**Operating Modes**

The ICs offer two modes of operation: normal mode and power-down mode. The logic state of the CS signal during a conversion activates these modes. The power-down mode can be used to optimize power dissipation with respect to sample rate.

**Normal Mode**

In normal mode, the devices are powered up at all times, thereby achieving their maximum throughput rates. Figure 7 shows the timing diagram of these devices in normal mode. The falling edge of CS samples the analog input signal, starts a conversion, and frames the serial-data transfer.
To remain in normal mode, keep $\overline{CS}$ low until the falling edge of the 10th SCLK cycle. Pulling $\overline{CS}$ high after the 10th SCLK falling edge keeps the part in normal mode.

However, pulling $\overline{CS}$ high before the 10th SCLK falling edge terminates the conversion, DOUT goes into high-impedance mode, and the device enters power-down mode. See Figure 8.

### Power-Down Mode

In power-down mode, all bias circuitry is shut down drawing typically only 1.3μA of leakage current. To save power, put the device in power-down mode between conversions. Using the power-down mode between conversions is ideal for saving power when sampling the analog input infrequently.

#### Entering Power-Down Mode

To enter power-down mode, drive $\overline{CS}$ high between the 2nd and 10th falling edges of SCLK (see Figure 8). By pulling $\overline{CS}$ high, the current conversion terminates and DOUT enters high impedance.

#### Exiting Power-Down Mode

To exit power-down mode, implement one dummy conversion by driving $\overline{CS}$ low for at least 10 clock cycles (see Figure 9). The data on DOUT is invalid during this dummy conversion. The first conversion following the dummy cycle contains a valid conversion result.

The power-up time equals the duration of the dummy cycle, and is dependent on the clock frequency. The power-up time for 500ksps operation (8MHz SCLK) is 2μs.
Supply Current vs. Sampling Rate

For applications requiring lower throughput rates, the user can reduce the clock frequency ($f_{SCLK}$) to lower the sample rate. Figure 11 shows the typical supply current ($I_{VDD}$) as a function of sample rate ($f_S$) for the 500ksps devices. The part operates in normal mode and is never powered down. The user can also power down the ADC between conversions by using the power-down mode. Figure 12 shows for the 500ksps device that as the sample rate is reduced, the device remains in the power-down state longer and the average supply current ($I_{VDD}$) drops accordingly.

![Figure 11. Supply Current vs. Sample Rate (Normal Operating Mode)](image1)

![Figure 12. Supply Current vs. Sample Rate (Device Powered Down Between Conversions)](image2)
Dual-Channel Operation

The MAX11662/MAX11664/MAX11666 feature dual-input channels. These devices use a channel-select (CHSEL) input to select between analog input AIN1 (CHSEL = 0) or AIN2 (CHSEL = 1). As shown in Figure 13, the CHSEL signal is required to change between the 2nd and 12th clock cycle within a regular conversion to guarantee proper switching between channels.

14-Cycle Conversion Mode

The ICs can operate with 14 cycles per conversion. Figure 14 shows the corresponding timing diagram. Observe that DOUT does not go into high-impedance mode. Also, observe that tACQ needs to be sufficiently long to guarantee proper settling of the analog input voltage. See the Electrical Characteristics table for tACQ requirements and the Analog Input section for a description of the analog inputs.

Applications Information

Layout, Grounding, and Bypassing

For best performance, use PCBs with a solid ground plane. Ensure that digital and analog signal lines are separated from each other. Do not run analog and digital (especially clock) lines parallel to one another or digital lines underneath the ADC package. Noise in the VDD power supply, OVD, and REF affects the ADC’s performance. Bypass the VDD, OVD, and REF to ground with 0.1µF and 10µF bypass capacitors. Minimize capacitor lead and trace lengths for best supply-noise rejection.

Choosing an Input Amplifier

It is important to match the settling time of the input amplifier to the acquisition time of the ADC. The conversion results are accurate when the ADC samples the input signal for an interval longer than the input signal’s worst-case settling time. By definition, settling time is the interval between the application of an input voltage step and the point at which the output signal reaches
and stays within a given error band centered on the resulting steady-state amplifier output level. The ADC input sampling capacitor charges during the sampling cycle, referred to as the acquisition period. During this acquisition period, the settling time is affected by the input resistance and the input sampling capacitance. This error can be estimated by looking at the settling of an RC time constant using the input capacitance and the source impedance over the acquisition time period.

Figure 15 shows a typical application circuit. The MAX4430, offering a settling time of 37ns at 16 bits, is an excellent choice for this application. See the THD vs. Input Resistance graph in the Typical Operating Characteristics.

Choosing a Reference
For devices using an external reference, the choice of the reference determines the output accuracy of the ADC. An ideal voltage reference provides a perfect initial accuracy and maintains the reference voltage independent of changes in load current, temperature, and time. Considerations in selecting a reference include initial voltage accuracy, temperature drift, current source, sink capability, quiescent current, and noise. Figure 15 shows a typical application circuit using the MAX6126 to provide the reference voltage. The MAX6033 and MAX6043 are also excellent choices.

Figure 15. Typical Application Circuit
500ksps, Low-Power, Serial 12-/10-/8-Bit ADCs

Definitions

Integral Nonlinearity
Integral nonlinearity (INL) is the deviation of the values on an actual transfer function from a straight line. For these devices, the straight line is a line drawn between the end points of the transfer function after offset and gain errors are nulled.

Differential Nonlinearity
Differential nonlinearity (DNL) is the difference between an actual step width and the ideal value of 1 LSB. A DNL error specification of ±1 LSB or less guarantees no missing codes and a monotonic transfer function.

Offset Error
The deviation of the first code transition (00 . . . 000) to (00 . . . 001) from the ideal, that is, AGND + 0.5 LSB.

Gain Error
The deviation of the last code transition (111 . . . 110) to (111 . . . 111) from the ideal after adjusting for the offset error, that is, VREF - 1.5 LSB.

Aperture Jitter
Aperture jitter (tAJ) is the sample-to-sample variation in the time between the samples.

Aperture Delay
Aperture delay (tAD) is the time between the falling edge of sampling clock and the instant when an actual sample is taken.

Signal-to-Noise Ratio (SNR)
SNR is a dynamic figure of merit that indicates the converter’s noise performance. For a waveform perfectly reconstructed from digital samples, the theoretical maximum SNR is the ratio of the full-scale analog input (RMS value) to the RMS quantization error (residual error). The ideal, theoretical minimum analog-to-digital noise is caused by quantization error only and results directly from the ADC’s resolution (N bits):

\[
\text{SNR (dB) (MAX)} = (6.02 \times N + 1.76) \text{ (dB)}
\]

In reality, there are other noise sources such as thermal noise, reference noise, and clock jitter that also degrade SNR. SNR is computed by taking the ratio of the RMS signal to the RMS noise. RMS noise includes all spectral components to the Nyquist frequency excluding the fundamental, the first five harmonics, and the DC offset.

Signal-to-Noise Ratio and Distortion (SINAD)
SINAD is a dynamic figure of merit that indicates the converter’s noise and distortion performance. SINAD is computed by taking the ratio of the RMS signal to the RMS noise plus distortion. RMS noise plus distortion includes all spectral components to the Nyquist frequency excluding the fundamental and the DC offset:

\[
\text{SINAD(dB) = } 20 \times \log \left( \frac{\text{SIGNAL}_{\text{RMS}}}{\text{NOISE + DISTORTION}_{\text{RMS}}} \right)
\]

Total Harmonic Distortion
Total harmonic distortion (THD) is the ratio of the RMS sum of the first five harmonics of the input signal to the fundamental itself. This is expressed as:

\[
\text{THD} = 20 \times \log \left( \frac{\sqrt{V_2^2 + V_3^2 + V_4^2 + V_5^2}}{V_1} \right)
\]

where V1 is the fundamental amplitude and V2–V5 are the amplitudes of the 2nd- through 5th-order harmonics.

Spurious-Free Dynamic Range (SFDR)
SFDR is a dynamic figure of merit that indicates the lowest usable input signal amplitude. SFDR is the ratio of the RMS amplitude of the fundamental (maximum signal component) to the RMS value of the next largest spurious component, excluding DC offset. SFDR is specified in decibels with respect to the carrier (dBc).

Full-Power Bandwidth
Full-power bandwidth is the frequency at which the input signal amplitude attenuates by 3dB for a full-scale input.

Full-Linear Bandwidth
Full-linear bandwidth is the frequency at which the signal-to-noise ratio and distortion (SINAD) is equal to a specified value.

Intermodulation Distortion
Any device with nonlinearities creates distortion products when two sine waves at two different frequencies (f1 and f2) are applied into the device. Intermodulation distortion (IMD) is the total power of the IM2 to IM5 intermodulation products to the Nyquist frequency relative to the total input power of the two input tones, f1 and f2. The individual input tone levels are at -6dBFS.
**Chip Information**

PROCESS: CMOS

**Package Information**

For the latest package outline information and land patterns (footprints), go to [www.maxim-ic.com/packages](http://www.maxim-ic.com/packages). Note that a “+”, “#”, or “-” in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

<table>
<thead>
<tr>
<th>PACKAGE TYPE</th>
<th>PACKAGE CODE</th>
<th>OUTLINE NO.</th>
<th>LAND PATTERN NO.</th>
</tr>
</thead>
<tbody>
<tr>
<td>10 µMAX</td>
<td>U10E+3</td>
<td>21-0109</td>
<td>90-0148</td>
</tr>
<tr>
<td>6 SOT23</td>
<td>U6+1</td>
<td>21-0058</td>
<td>90-0175</td>
</tr>
</tbody>
</table>
**Revision History**

<table>
<thead>
<tr>
<th>REVISION NUMBER</th>
<th>REVISION DATE</th>
<th>DESCRIPTION</th>
<th>PAGES CHANGED</th>
</tr>
</thead>
<tbody>
<tr>
<td>0</td>
<td>11/10</td>
<td>Initial release</td>
<td>—</td>
</tr>
<tr>
<td>1</td>
<td>1/11</td>
<td>Released the MAX11663 and updated Figures 11 and 12.</td>
<td>1, 23</td>
</tr>
<tr>
<td>2</td>
<td>6/11</td>
<td>Released the MAX11662/MAX11664/MAX11666. Updated the Electrical Characteristics.</td>
<td>1–14</td>
</tr>
<tr>
<td>3</td>
<td>11/11</td>
<td>Updated the Electrical Characteristics, Figures 13 and 15.</td>
<td>4, 5, 6, 8, 10, 12, 14, 24, 25</td>
</tr>
<tr>
<td>4</td>
<td>1/12</td>
<td>Updated Ordering Information.</td>
<td>1</td>
</tr>
<tr>
<td>5</td>
<td>4/12</td>
<td>Corrected the Aperture Delay in the Electrical Characteristics</td>
<td>3</td>
</tr>
</tbody>
</table>

Maxim cannot assume responsibility for use of any circuitry other than circuitry entirely embodied in a Maxim product. No circuit patent licenses are implied. Maxim reserves the right to change the circuitry and specifications without notice at any time. The parametric values (min and max limits) shown in the Electrical Characteristics table are guaranteed. Other parametric values quoted in this data sheet are provided for guidance.